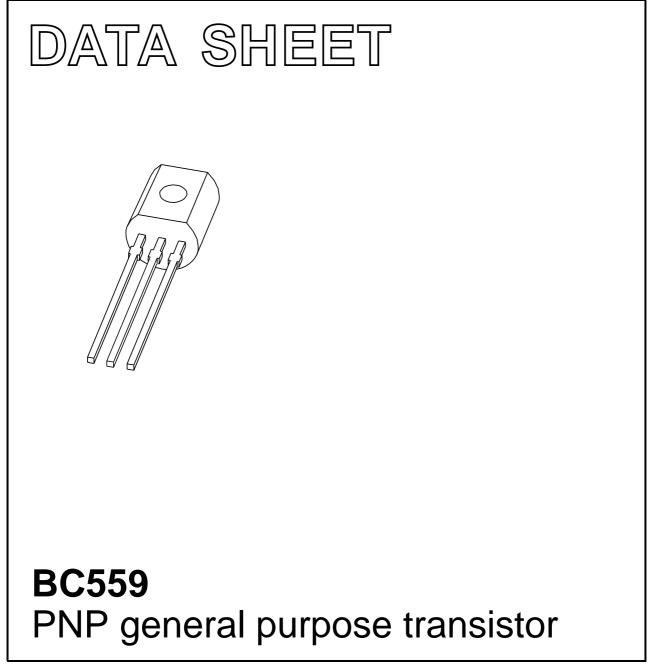
DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 1999 May 28 2004 Nov 05



Product data sheet

PNP general purpose transistor

FEATURES

- Low current (max. 100 mA)
- Low voltage (max. 30 V).

APPLICATIONS

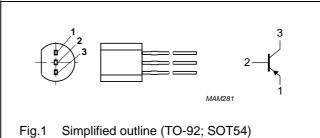
• General purpose switching and amplification.

DESCRIPTION

PNP transistor in a TO-92 (SOT54) plastic package. NPN complement: BC549.

PINNING

PIN	DESCRIPTION	
1	emitter	
2	base	
3	collector	



and symbol.

ORDERING INFORMATION

TYPE NUMBER		PACKAGE		
ITPE NUMBER	NAME DESCRIPTION		VERSION	
BC559C	SC-43A	plastic single-ended leaded (through hole) package; 3 leads		

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	-30	V
V _{CEO}	collector-emitter voltage	open base	—	-30	V
V _{EBO}	emitter-base voltage	open collector	—	-5	V
I _C	collector current (DC)		—	-100	mA
I _{CM}	peak collector current		_	-200	mA
I _{BM}	peak base current		—	-200	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	_	500	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C

BC559

PNP general purpose transistor

BC559

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	250	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -30 \text{ V}; \text{ I}_{E} = 0 \text{ A}$	-	-1	-15	nA
		$V_{CB} = -30 \text{ V}; \text{ I}_{E} = 0 \text{ A}; \text{ T}_{j} = 150 ^{\circ}\text{C}$	_	_	-4	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	_	_	-100	nA
h _{FE}	DC current gain; BC559C	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -2 \text{ mA}; \text{ see Fig.2}$	420	_	800	
V _{CEsat}	collector-emitter saturation	$I_{\rm C} = -10$ mA; $I_{\rm B} = -0.5$ mA	-	-60	-300	mV
	voltage	$I_{\rm C} = -100 \text{ mA}; I_{\rm B} = -5 \text{ mA}$	_	-180	-650	mV
V _{BEsat}	base-emitter saturation voltage	$I_{C} = -10 \text{ mA}; I_{B} = -0.5 \text{ mA}; \text{ note } 1$	_	-750	_	mV
		$I_{\rm C} = -100 \text{ mA}; I_{\rm B} = -5 \text{ mA}; \text{ note } 1$	-	-930	-	mV
V _{BE}	base-emitter voltage	$V_{CE} = -5 \text{ V}; I_{C} = -2 \text{ mA}; \text{ note } 2$	-600	-650	-750	mV
		$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -10 \text{ mA}; \text{ note } 2$	_	_	-820	mV
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	-	4	-	pF
f _T	transition frequency	$V_{CB} = -5 \text{ V}; I_E = -10 \text{ mA}; f = 100 \text{ MHz}$	100	_	_	MHz
F	noise figure; BC559C	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -200 \mu\text{A}; \text{ R}_{S} = 2 k\Omega;$	_	-	4	dB
		f = 30 Hz to 15.7 kHz				
		$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -200 \mu\text{A}; \text{ R}_{S} = 2 k\Omega;$ f = 1 kHz; B = 200 Hz	-	-	4	dB

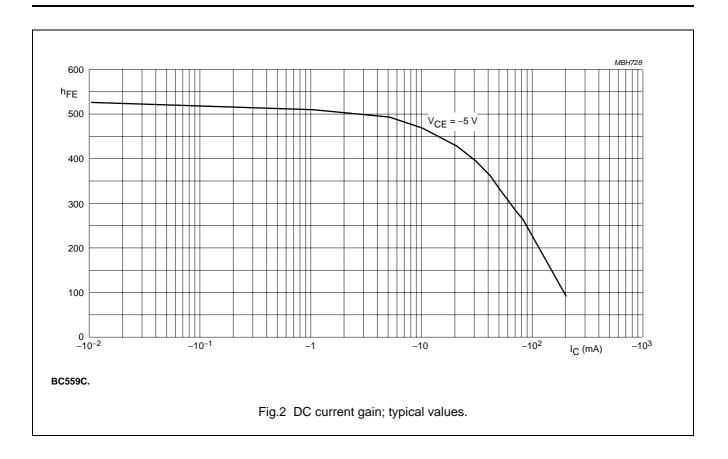
Notes

- 1. V_{BEsat} decreases by about -1.7 mV/K with increasing temperature.
- 2. V_{BE} decreases by about -2 mV/K with increasing temperature.

Product data sheet

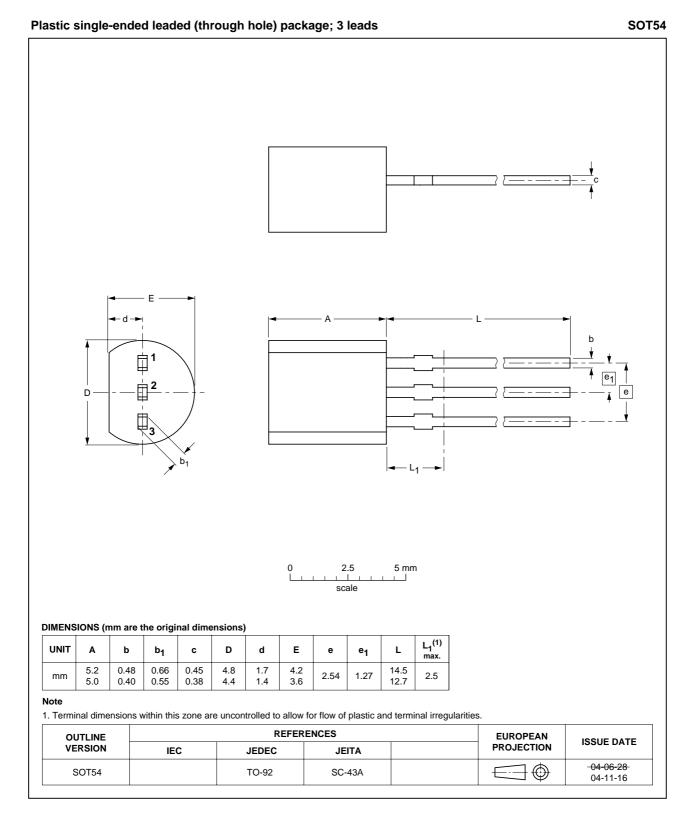
BC559

PNP general purpose transistor



PNP general purpose transistor

PACKAGE OUTLINE



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BC559

PNP general purpose transistor

BC559

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

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